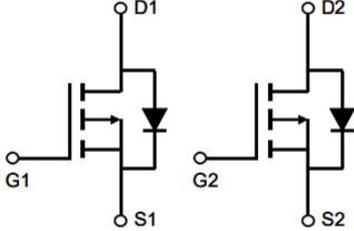
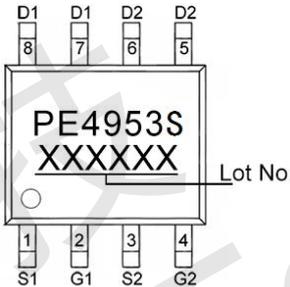
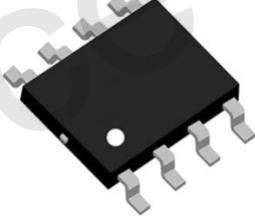




P-Channel Enhancement Mode Power MOSFET

| | |
|---|--|
| <p>Description</p> <p>The PE4953S uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> • $V_{DS} = -30V, I_D = -5.3A$ • $R_{DS(ON)} < 50m\Omega @ V_{GS} = -10V$ • $R_{DS(ON)} < 72m\Omega @ V_{GS} = -4.5V$ • High Power and current handing capability • Lead free product is acquired • Surface Mount Package <p>Application</p> <ul style="list-style-type: none"> • PWM applications • Load switch • Power management | <div style="text-align: center;">  <p>Schematic diagram</p> </div> <div style="text-align: center; margin-top: 20px;">  <p>Marking and pin assignment</p> </div> <div style="text-align: center; margin-top: 20px;">  <p>SOP-8</p> </div> |
|---|--|

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| Parameter | Symbol | Rating | Unit |
|--|----------------|------------|------|
| Drain-Source Voltage | V_{DS} | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | -5.3 | A |
| Pulsed Drain Current (Note 1) | I_{DM} | -20 | A |
| Maximum Power Dissipation | P_D | 2 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | °C |

Thermal Characteristic

| | | | |
|--|-----------------|------|------|
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 62.5 | °C/W |
|--|-----------------|------|------|



Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|--|-----|------|-----------|------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=-250\mu A$ | -30 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=-30V, V_{GS}=0V$ | - | - | -1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=-250\mu A$ | -1 | -1.5 | -2.5 | V |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | $V_{GS}=-10V, I_D=-4.1A$ | - | 39 | 50 | m Ω |
| | | $V_{GS}=-4.5V, I_D=-4A$ | - | 54 | 72 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=-15V, I_D=-4.5A$ | 4 | 7 | - | S |
| Dynamic Characteristics (Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=-15V, V_{GS}=0V,$ $F=1.0MHz$ | - | 400 | - | pF |
| Output Capacitance | C_{oss} | | - | 70 | - | pF |
| Reverse Transfer Capacitance (Note 4) | C_{rss} | | - | 60 | - | pF |
| Switching Characteristics | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=-15V, I_D=-1A, R_L=1\Omega,$ $V_{GS}=-10V, R_G=6\Omega$ | - | 8 | - | nS |
| Turn-on Rise Time | t_r | | - | 14 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 18 | - | nS |
| Turn-Off Fall Time | t_f | | - | 10 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=-15V, I_D=-4A,$ $V_{GS}=-10V$ | - | 12 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 2.4 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 3.2 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V_{SD} | $V_{GS}=0V, I_S=-1A$ | - | - | -1.2 | V |
| Diode Forward Current (Note 2) | I_S | | - | - | -5 | A |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product.



Typical Electrical and Thermal Characteristics

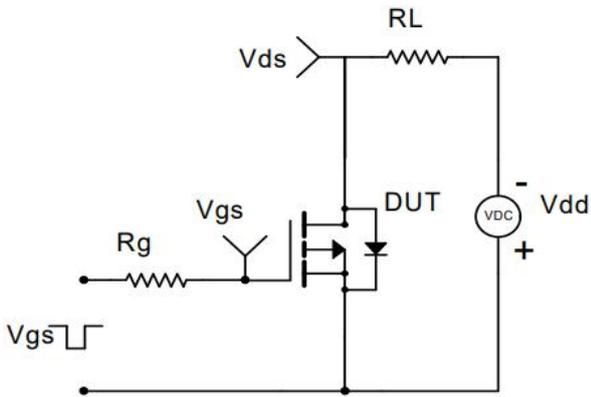


Figure 1 Switching Test Circuit

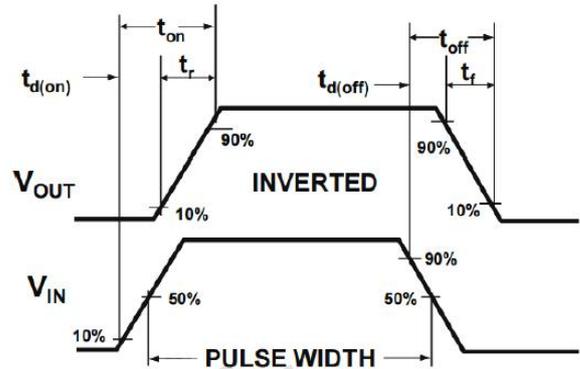


Figure 2 Switching Waveform

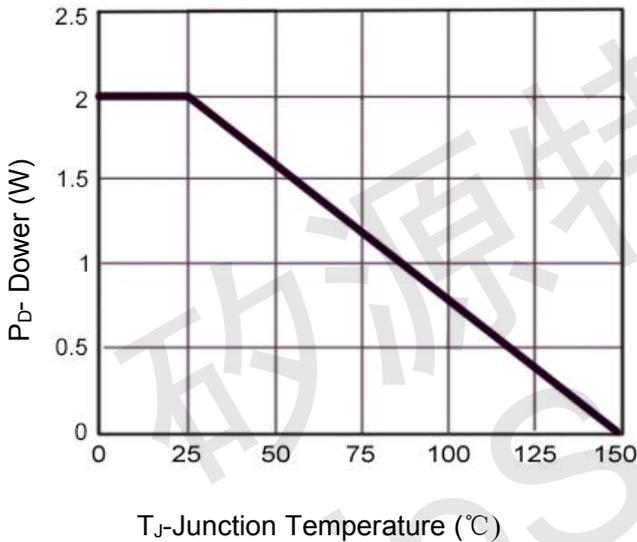


Figure 3 Power De-rating

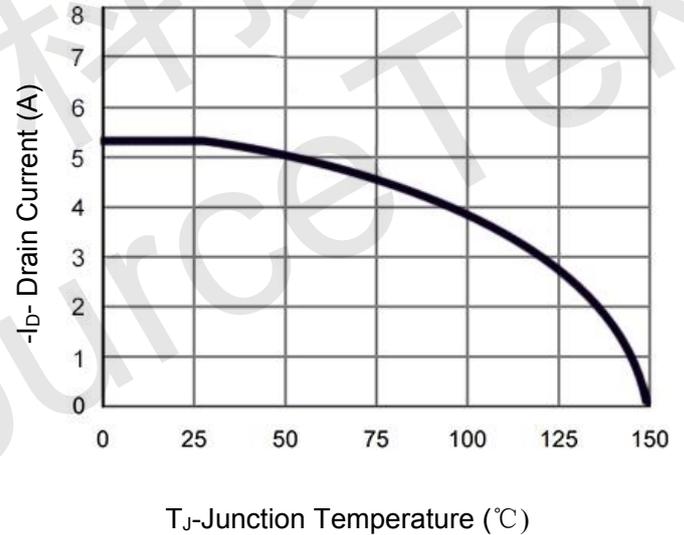


Figure 4 Drain Current

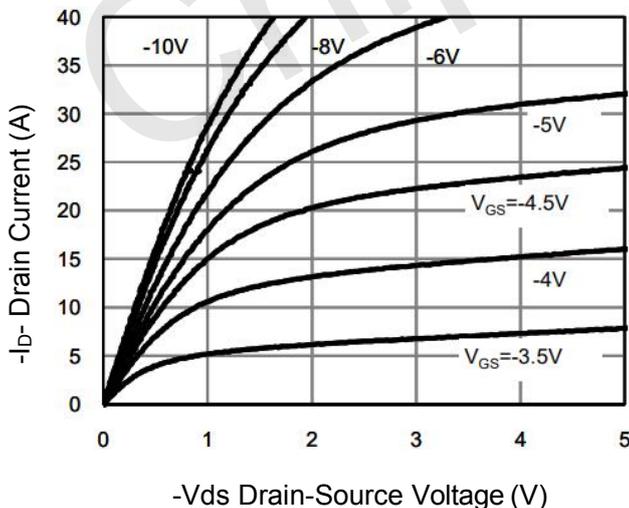


Figure 5 Output Characteristics

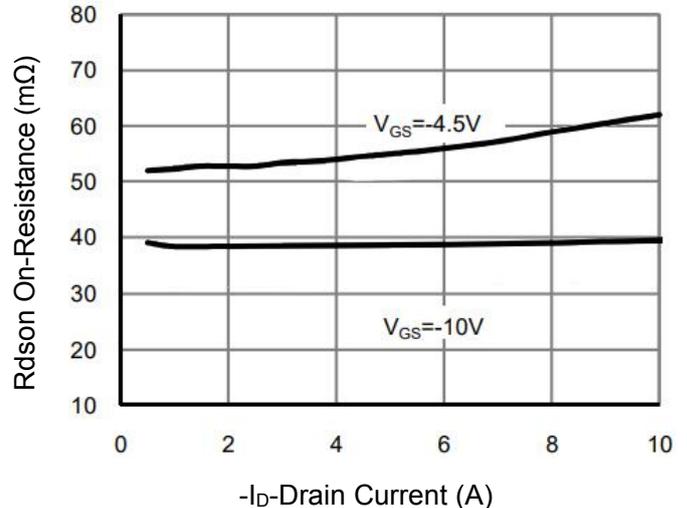


Figure 6 Rdson vs Drain Current

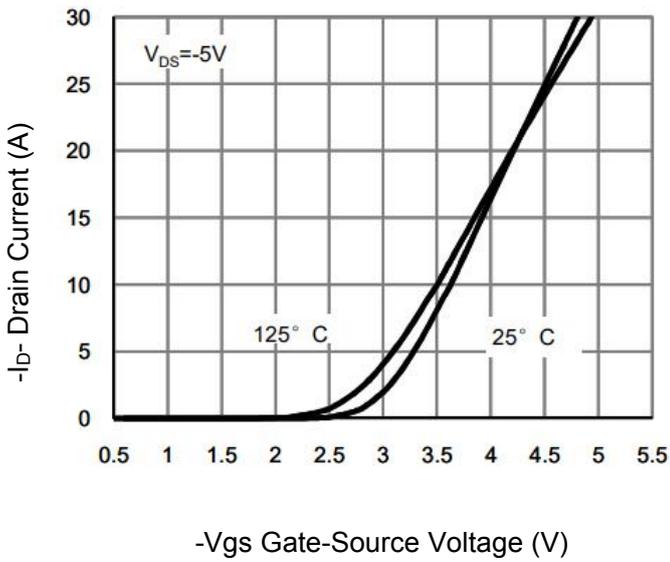


Figure 7 Transfer Characteristics

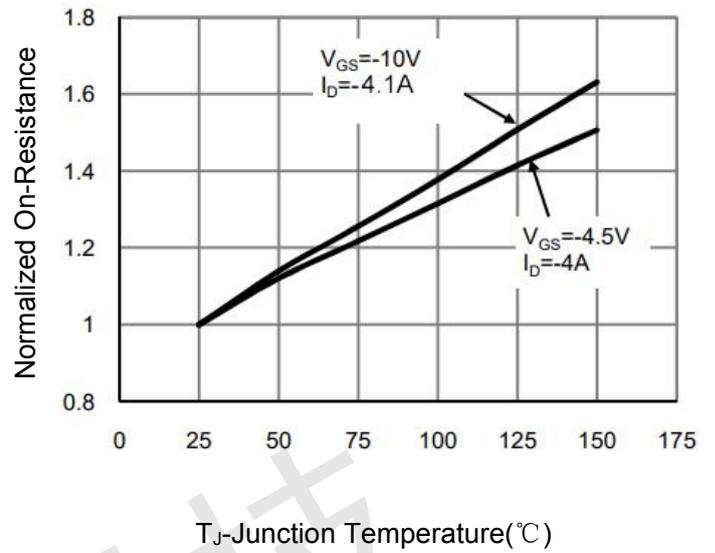


Figure 8 Rdson vs Junction Temperature

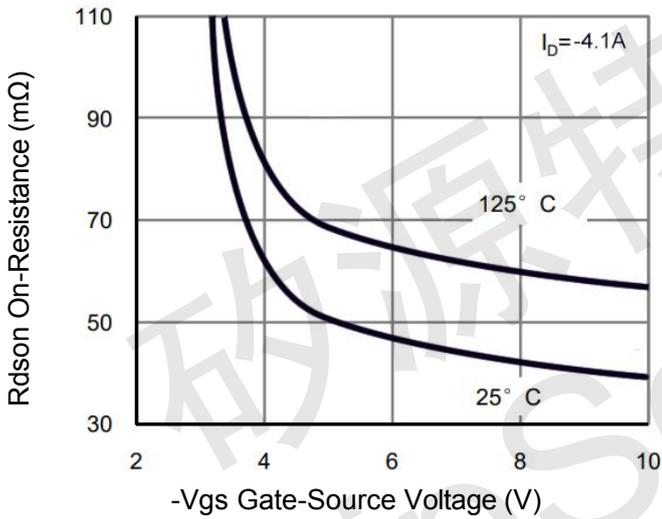


Figure 9 Rdson vs Vgs

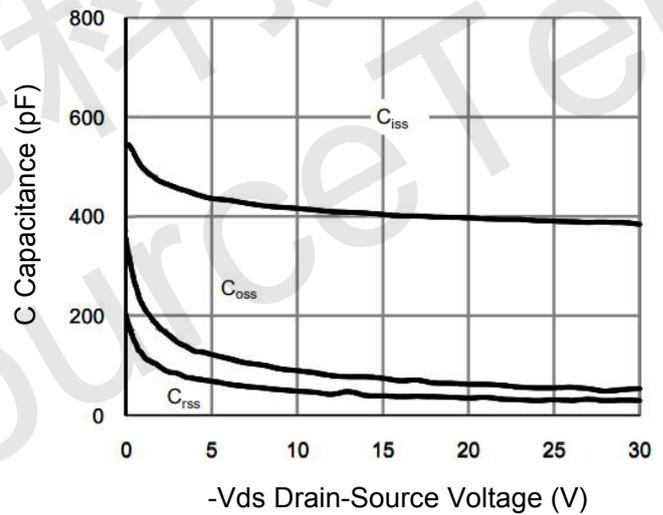


Figure 10 Capacitance vs Vds

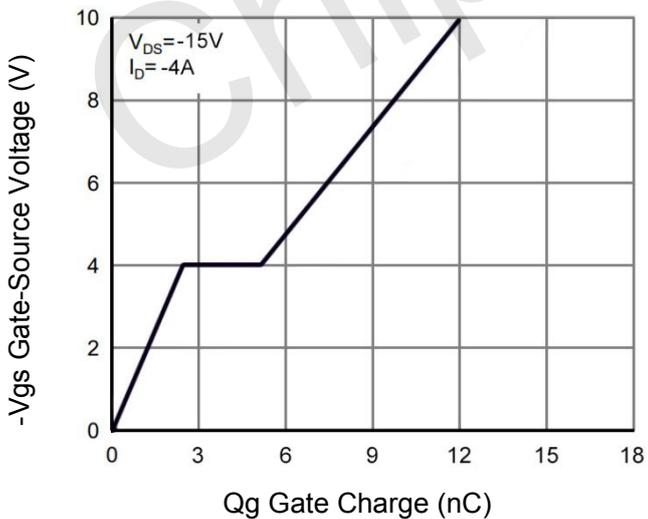


Figure 11 Gate Charge

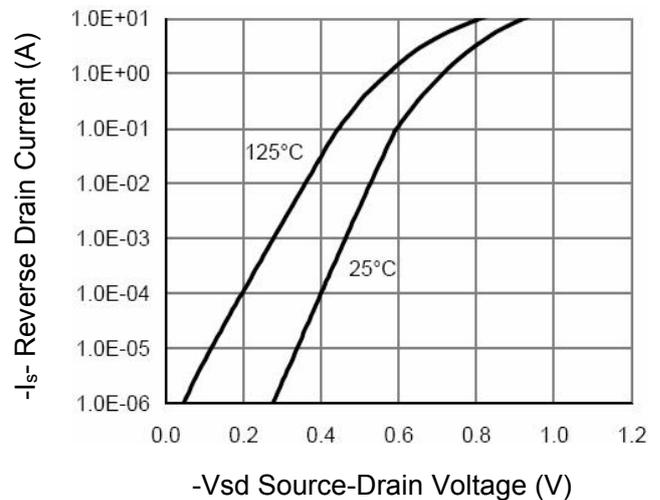


Figure 12 Source- Drain Diode Forward

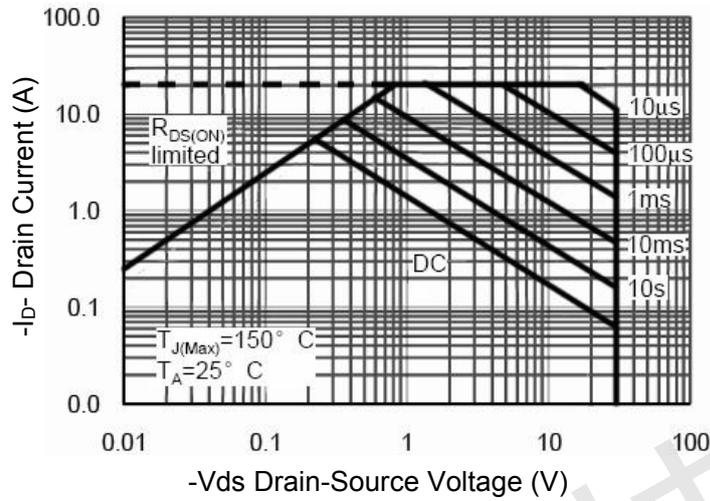


Figure 13 Safe Operation Area

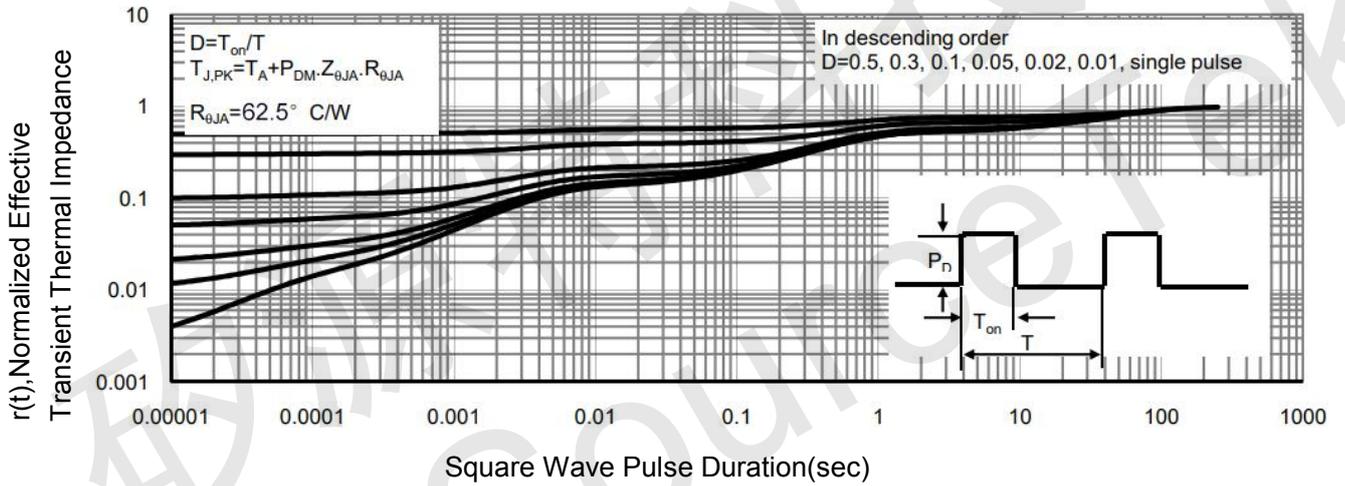
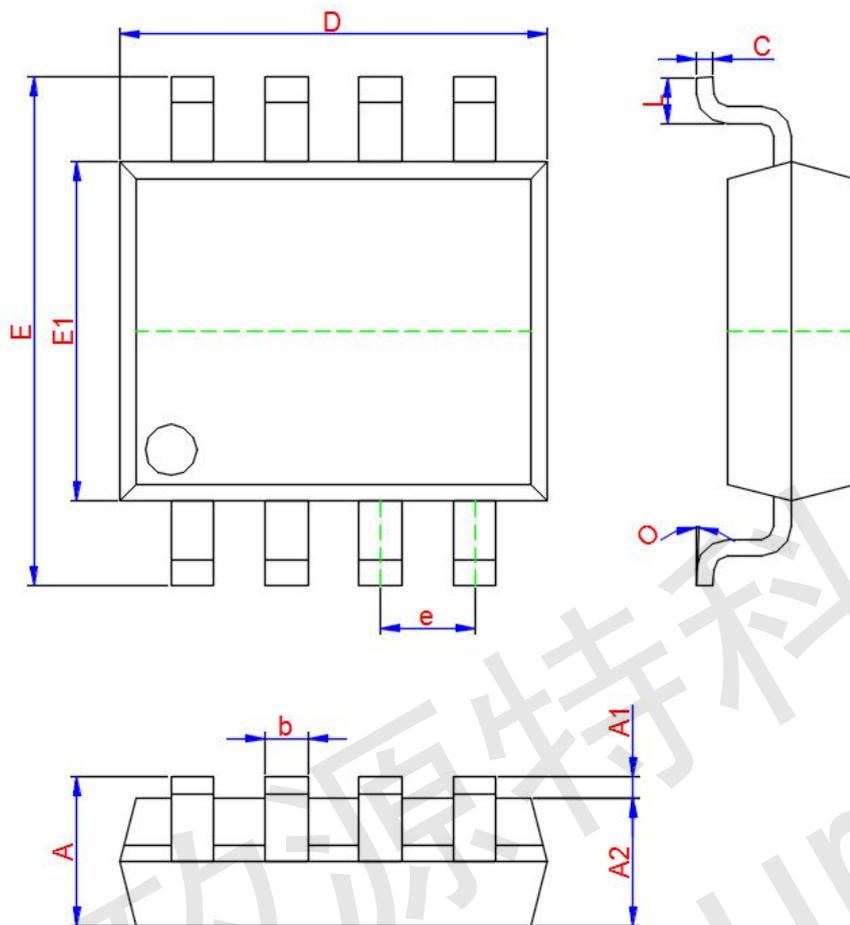


Figure 14 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



| Symbol | Dimensions In Millimeters | | |
|--------|---------------------------|-------|-------|
| | Min. | Typ. | Max. |
| A | 1.350 | 1.550 | 1.750 |
| A1 | 0.100 | 0.175 | 0.250 |
| A2 | 1.350 | 1.450 | 1.550 |
| b | 0.330 | 0.420 | 0.510 |
| c | 0.170 | 0.210 | 0.250 |
| D | 4.700 | 4.900 | 5.100 |
| e | 1.270 TYP. | | |
| E | 5.800 | 6.000 | 6.200 |
| E1 | 3.750 | 3.900 | 4.050 |
| L | 0.400 | 0.835 | 1.270 |
| O | 0° | 4° | 8° |